Unit in mm

### TOSHIBA LED LAMP InGaA&P ORANGE LIGHT EMISSION

# **TLOH156P**

#### PANEL CIRCUIT INDICATOR

- 5 mm DIAMETER (T1-3/4)
- InGaAlP ORANGE LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Orange Light Emission Recommended Forward Current : I<sub>F</sub> = 1~20 mA (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- Without stand-offs
- APPLICATIONS: Suitable for Outdoor Message Signboard, Safety equipment, automotive use.

### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current (DC)	${ m I_F}$	50	mA
Reverse Voltage	$v_{R}$	4	V
Power Dissipation	$P_{\mathrm{D}}$	125	mW
Operating Temperature Range	$T_{ m opr}$	-30~85	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~120	$^{\circ}\mathrm{C}$

2.54 CATHODE INDEX

ANODE
 CATHODE

JEDEC —
EIAJ —
TOSHIBA

Weight: 0.31 g

2001-06-01

# ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Forward Voltage V <sub>F</sub>		$ m V_{f F}$	$I_{ m F}=20~{ m mA}$	_	2.1	2.5	V
Reverse Current I <sub>R</sub>		$V_R = 4 V$	_	_	50	$\mu$ A	
Luminous	TLOH156P	$I_{ m V}$	$I_{\mathrm{F}} = 20  \mathrm{mA}   \mathrm{(Note)}$	476	1500	_	mcd
Intensity	TLOH156P (ST)			850	_	4140	
Peak Emission Wavelength		$\lambda_{\mathbf{p}}$	$I_{ m F}=20~{ m mA}$	_	612	_	nm
Spectral Line Half Width		Δλ	$I_{ m F}=20~{ m mA}$	_	15	_	nm
Dominant Wavelength		$^{\lambda}\mathbf{d}$	$I_{ m F}=20~{ m mA}$	_	605	_	nm

(Note): Lamps are classified into the following ranks according to their luminous intensity. Measurement tolerance for each limit is  $\pm 15\%$ .

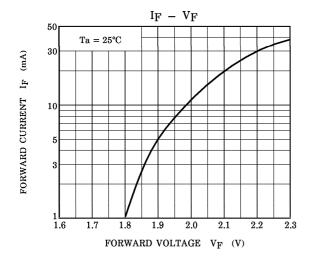
R: 560-1120 mcd, S: 1000-2000 mcd, T: 1800-3600 mcd.

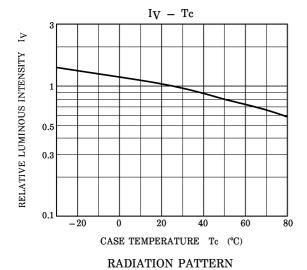
## **PRECAUTION**

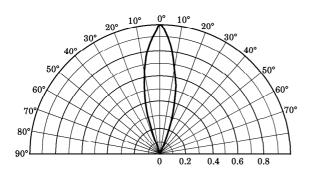
Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

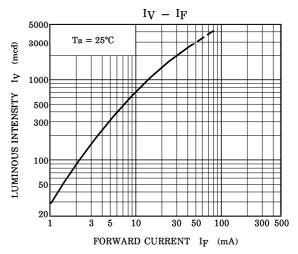
2 2001-06-01

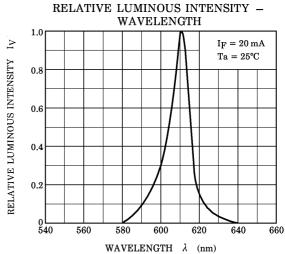


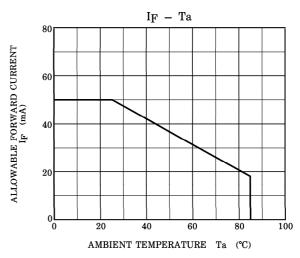




 $Ta = 25^{\circ}C$ 







3 2001-06-01

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